



Reflow Vapor Phase Machine

For Individual and Series Production

SV540



The SV540 combines a slim design for a small footprint with a 2-chamber system. With the adjustable solder automatic it allows the highest soldering quality. Especially designed for prototyping and small series production, she masters the soldering of BGAs and LGAs.



√ Touchpanel

 $\sqrt{}$ Manually carrier in- and output

√ Obersvation window to process chamber

√ Energy management system

√ Fully automatic solder cycle

ee Integrated cooling fan

Integrated exhaust system

 $\sqrt{}$ Automatic medium filtering



Overview

- Powerful front loader with small footprint
- 2-chamber design for low consumption
- Oxygen free soldering
- No overheating of components
- N o△T´s throughout the assembly

SPECIAL FEATURES

Maintenance-free transport system (patented)

Low medium consumption with 2-chamber design and medium recovery

Program memory for up to 16 programs

Easy profil recording option

Easy access to process chamber



Options

- Adapter for double sided PCB's
- ReSy, Reworksystem
- Stainless steel grid for the workpiece carrier
- Closed-loop-chiller
- TE-Option (2 channels) for external profile monitoring
- USB profiling system



Leading in Vapor Phase Technology

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Technical Data	SV540
Length (over all)	1450 mm
Depth	796 mm
Hight	1450 mm
Weight	330 kg
Max. board size	540 x 360 x 80 mm
Medium agent filling	12 kg
Water connection	½" / 2,5-5 bar / 2 l/min
Max. heating capacity	5,2 kW
Ø power consumption	2,8 kW/h
Power supply	230/400 VAC, 50/60 Hz
Main fuse	16 A, Typ "gL" or "C"

⁻ Technical changes reserved -